Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

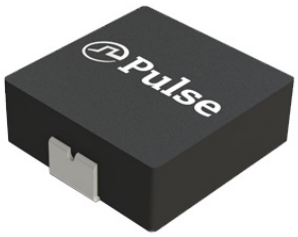
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

SMT Power Inductor

High Current Molded Power Inductor - PA4342.XXXNLT Series



- ***Height:*** *4.0mm Max*
- ***Footprint:*** *11.5mm x 10.3mm Max*
- ***Current Rating:*** *up to 43.0A*
- ***Inductance Range:*** *0.15uH to 68.0uH*
- *Shielded construction and compact design*
- *High current, low DCR, and high efficiency*
- *Minimized acoustic noise and minimized leakage flux*
- *200Vdc Isolation between terminal and core*

Electrical Specifications @ 25°C – Operating Temperature -40°C to +125°C

Part Number	Inductance 100KHz, 1V	Rated Current	DC Resistance		Saturation Current Max.	Mechanical
			MAX.	TYP.		
	uH	A	mΩ	mΩ	A	
PA4342.151NLT	0.15±30%	43.0	0.6	0.5	75.0	Footprint 1
PA4342.221NLT	0.22±20%	35.0	1.0	0.8	60.0	Footprint 1
PA4342.271NLT	0.27±20%	33.0	1.0	0.82	60.0	Footprint 1
PA4342.361NLT	0.36±20%	31.0	1.2	1.05	60.0	Footprint 1
PA4342.391NLT	0.39±20%	30.0	1.3	1.1	60.0	Footprint 1
PA4342.451NLT	0.45±20%	29.0	1.5	1.3	45.0	Footprint 1
PA4342.471NLT	0.47±20%	28.0	1.5	1.3	43.0	Footprint 1
PA4342.561NLT	0.56±20%	25.0	1.8	1.6	40.0	Footprint 1
PA4342.681NLT	0.68±20%	22.0	2.7	2.4	39.0	Footprint 1
PA4342.102NLT	1.00±20%	18.0	3.3	3.0	36.0	Footprint 1
PA4342.122NLT	1.20±20%	17.0	3.8	3.3	33.0	Footprint 1
PA4342.152NLT	1.50±20%	16.0	4.6	4.0	33.0	Footprint 2
PA4342.222NLT	2.20±20%	12.0	7.0	6.5	27.0	Footprint 2
PA4342.252NLT	2.50±20%	11.5	8.7	7.9	23.0	Footprint 2
PA4342.332NLT	3.30±20%	11.0	11.8	10.8	20.0	Footprint 2
PA4342.402NLT	4.00±20%	10.2	15.0	13.0	18.0	Footprint 2
PA4342.472NLT	4.70±20%	10.0	15.5	15.0	17.0	Footprint 2
PA4342.562NLT	5.60±20%	9.0	19.3	17.0	14.0	Footprint 2
PA4342.682NLT	6.80±20%	8.5	23.3	17.5	13.5	Footprint 2

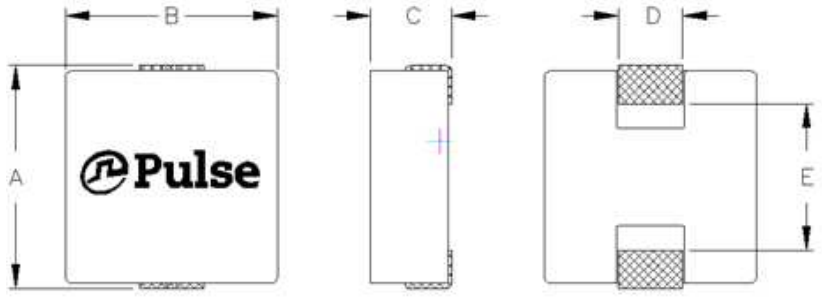
Electrical Specifications @ 25°C – Operating Temperature -40°C to +125°C						
Part Number	Inductance 100KHz, 1V	Rated Current	DC Resistance		Saturation Current Max.	Mechanical
			MAX.	TYP.		
	uH	A	mΩ	mΩ	A	
PA4342.822NLT	8.20±20%	8.0	25.5	20.0	12.5	Footprint 2
PA4342.103NLT	10.0±20%	7.5	30.0	27.0	12.0	Footprint 2
PA4342.153NLT	15.0±20%	6.25	45.0	40.0	10.0	Footprint 2
PA4342.223NLT	22.0±20%	5.0	74.0	64.0	7.0	Footprint 2
PA4342.273NLT	27.0±20%	4.0	100.0	86.0	6.0	Footprint 2
PA4342.333NLT	33.0±20%	3.5	112.0	92.0	5.0	Footprint 2
PA4342.473NLT	47.0±20%	3.0	167.0	145.0	4.5	Footprint 2
PA4342.683NLT	68.0±20%	2.0	240.0	205.0	3.0	Footprint 2

Notes:

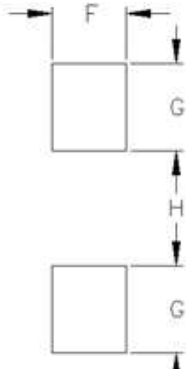
1. Actual temperature of the component during system operation (ambient plus temperature rise) must be within the standard operating range.
2. The saturation current is the current at which the initial inductance drops approximately 30% at the stated ambient temperature. This current is determined by placing the component in the specified ambient environment and applying a short duration pulse current (to eliminate self-heating effect) to the component.
3. The rated current is the DC current required to raise the component temperature by approximately 40˚C. Take note that the components' performanc varies depending on the system condition. It is suggested that the component be tested at the system level, to verify the temperature rise of the component during system operation.
4. The part temperature (ambient+temp rise) should not exceed 125˚C under worst case operating conditions. Circuit design, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

Mechanical

PA4342.XXXNLT



Final Layout



SUGGESTED PAD LAYOUT

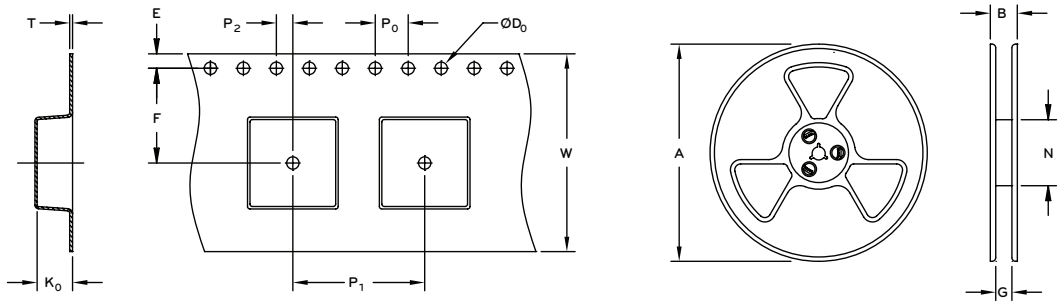
Series	Mechanical	A	B	C	D	E	F	G	H
PA4342.XXXNLT	Footprint 1	11.5 Max	10.3 Max	4.0 Max	(2.5)	(6.4)	(3.0)	(4.1)	(5.4)
PA4342.XXXNLT	Footprint 2	11.5 Max	10.3 Max	4.0 Max	(3.0)	(6.4)	(3.5)	(4.1)	(5.4)

All Dimensions in mm.

SMT Power Inductor

High Current Molded Power Inductor - PA4342.XXXNLT Series

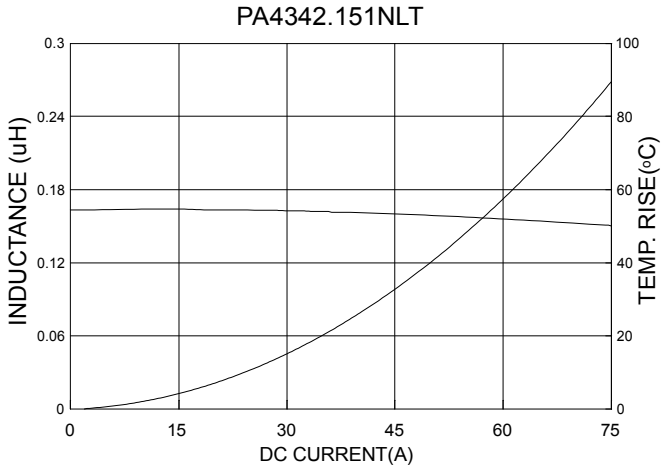
TAPE & REEL INFO

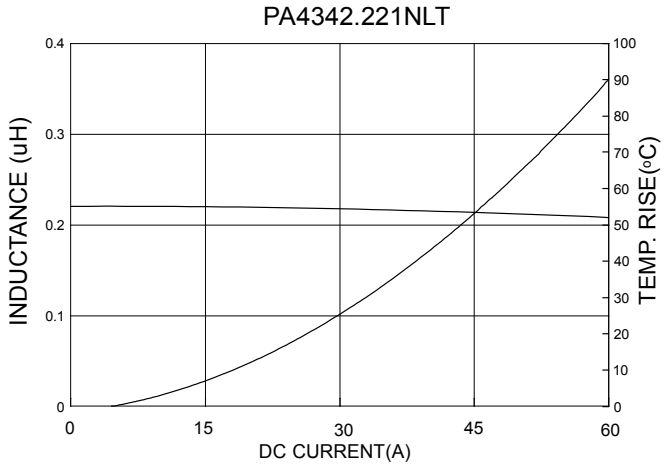


SURFACE MOUNTING TYPE, REEL/TAPE LIST

	REEL SIZE (mm)				TAPE SIZE (mm)									QTY
	A	B	G	N	E	F	D_0	P_1	P_0	P_2	W	T	K_0	PCS/REEL
PA4342.XXXNLT	Ø330	N/A	24	100	1.75	11.5	1.5	16	4	2	24	0.35	4.5	500

Typical Performance Curves

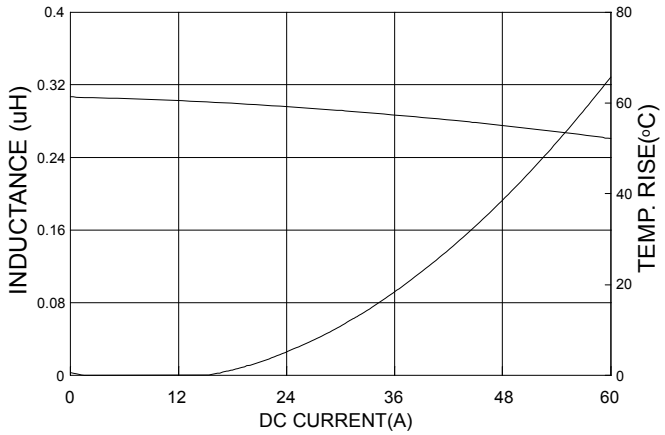




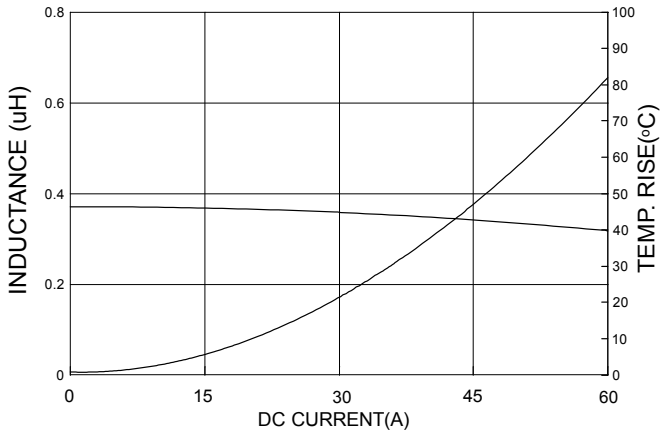
SMT Power Inductor

High Current Molded Power Inductor - PA4342.XXXNLT Series

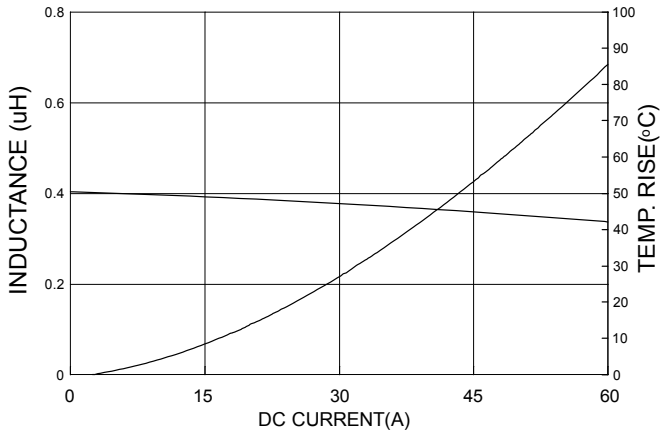
PA4342.271NLT



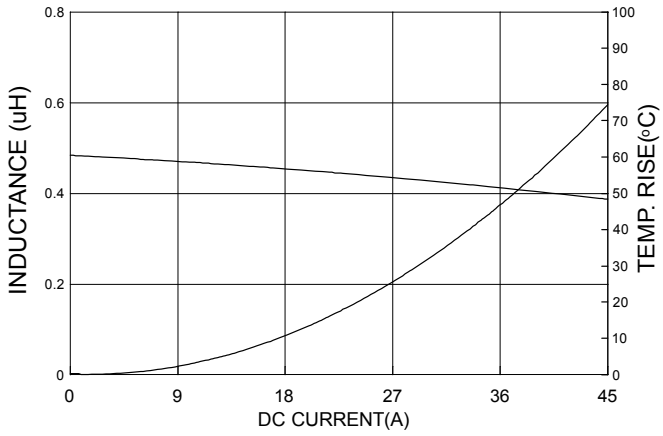
PA4342.361NLT



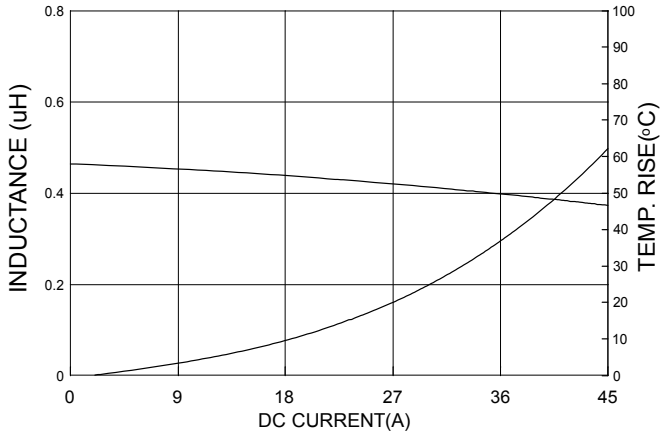
PA4342.391NLT



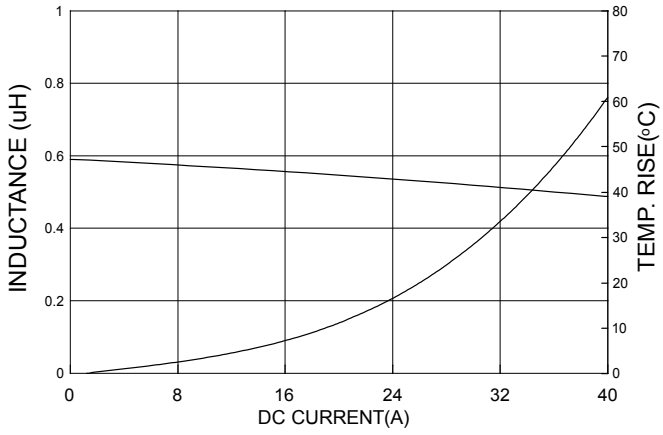
PA4342.451NLT



PA4342.471NLT



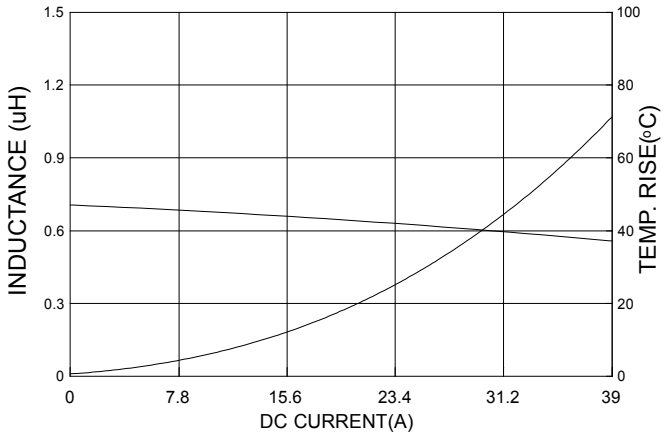
PA4342.561NLT



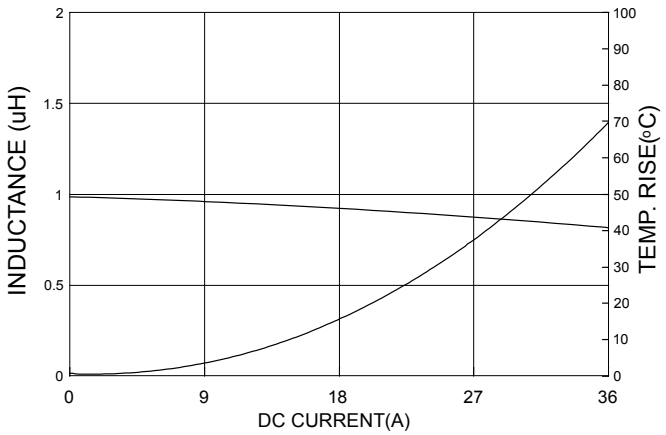
SMT Power Inductor

High Current Molded Power Inductor - PA4342.XXXNLT Series

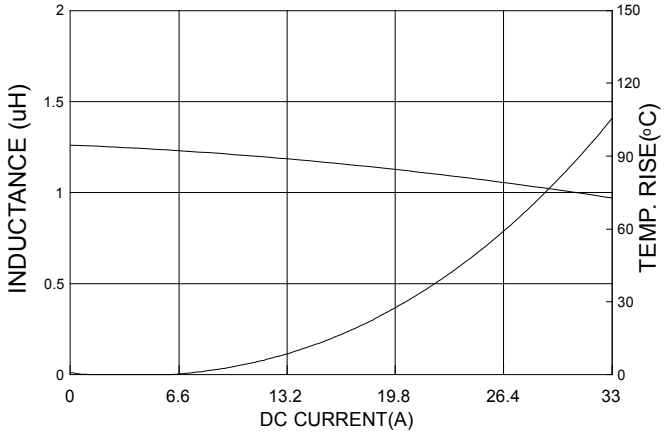
PA4342.681NLT



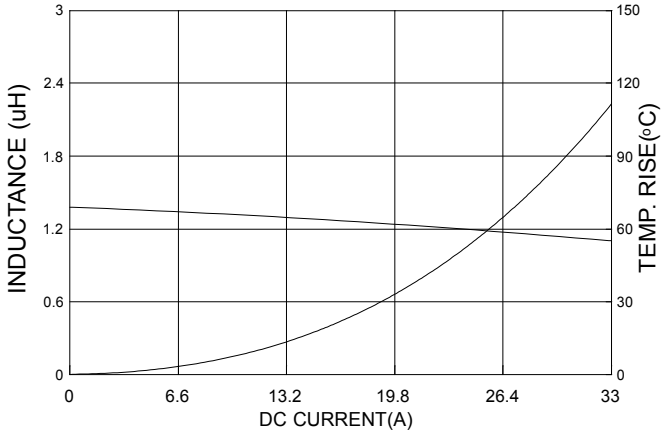
PA4342.102NLT



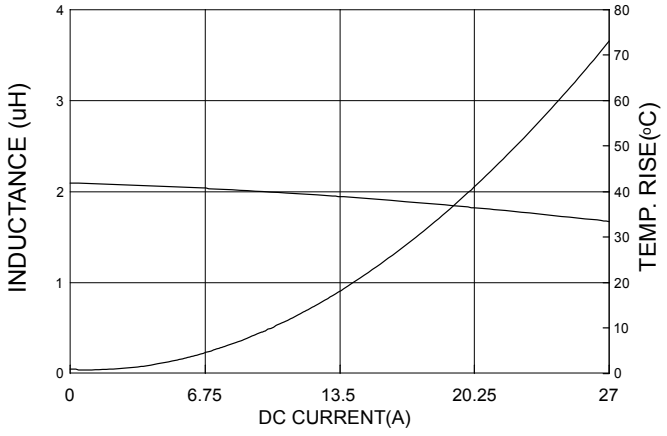
PA4342.122NLT



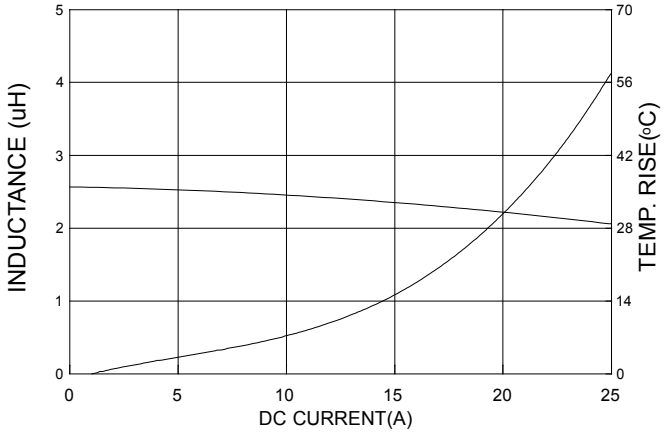
PA4342.152NLT



PA4342.222NLT



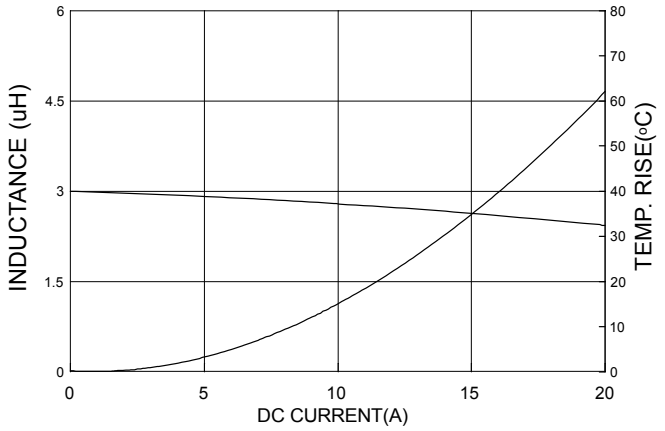
PA4342.252NLT



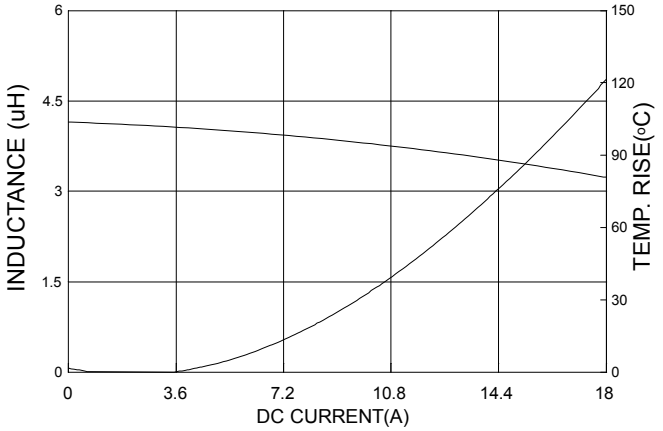
SMT Power Inductor

High Current Molded Power Inductor - PA4342.XXXNLT Series

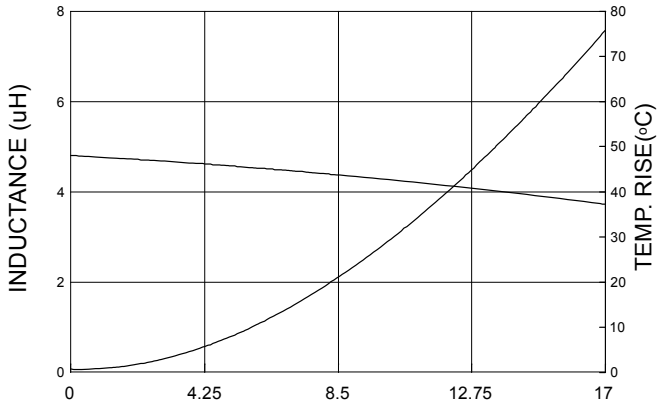
PA4342.332NLT



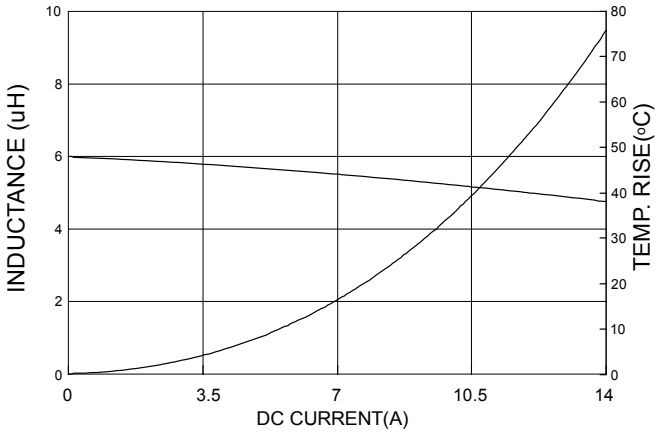
PA4342.402NLT



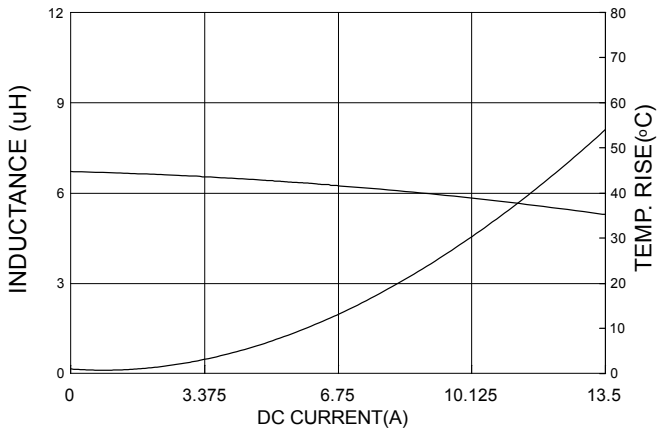
PA4342.472NLT



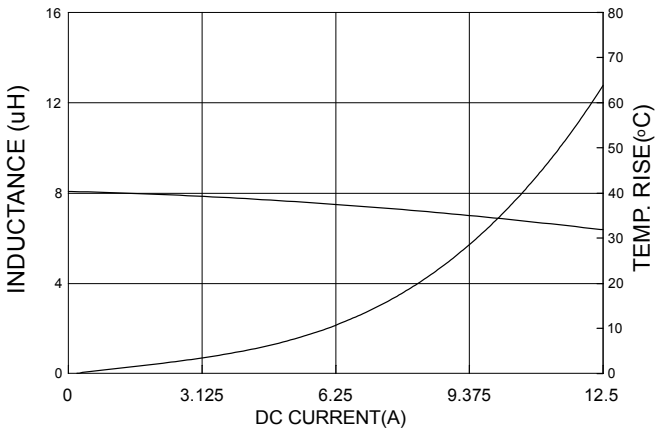
PA4342.562NLT



PA4342.682NLT



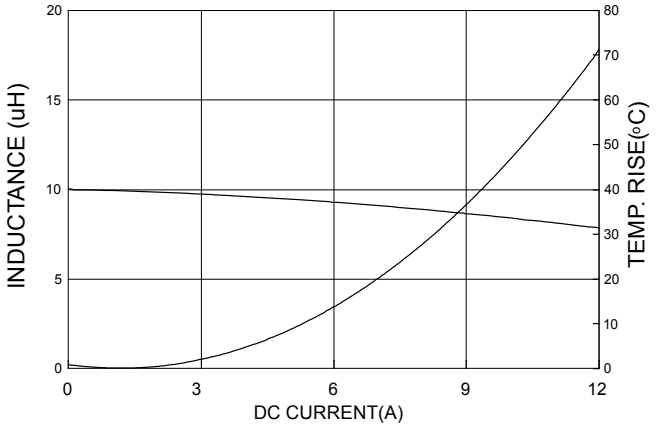
PA4342.822NLT



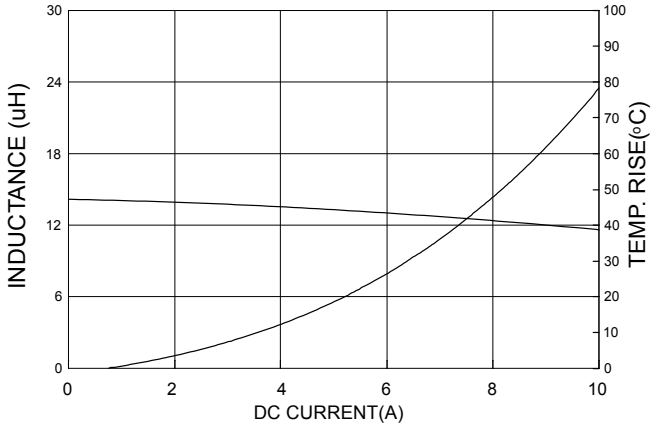
SMT Power Inductor

High Current Molded Power Inductor - PA4342.XXXNLT Series

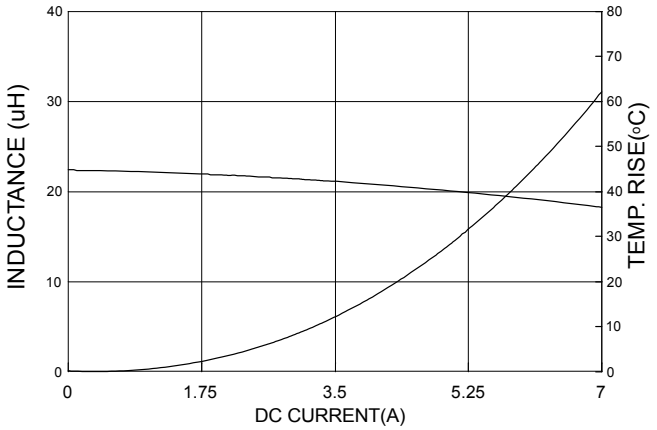
PA4342.103NLT



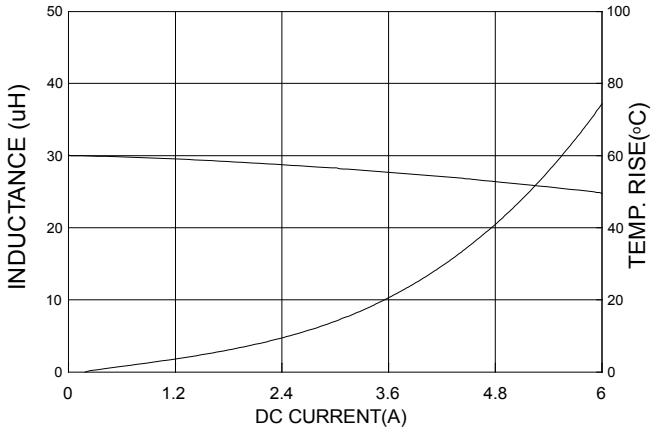
PA4342.153NLT



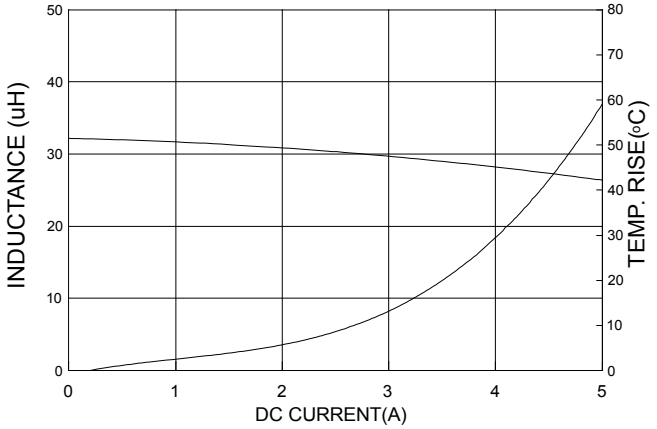
PA4342.223NLT



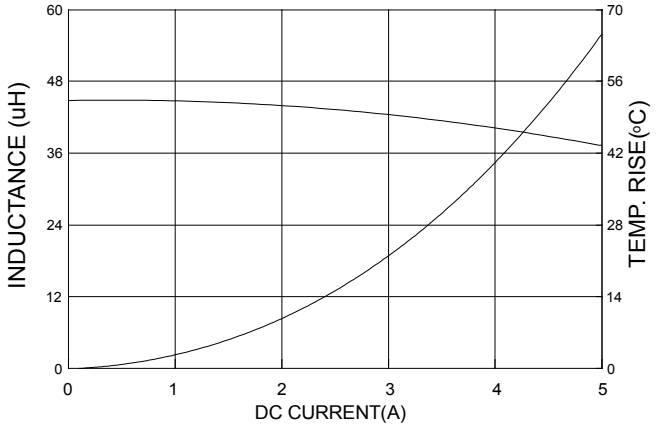
PA4342.273NLT



PA4342.333NLT

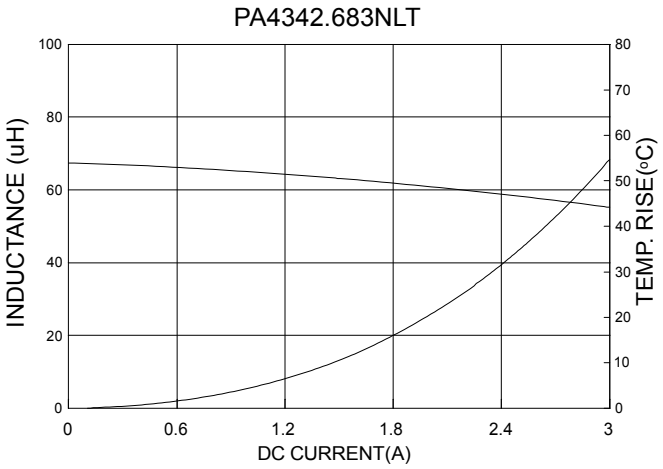


PA4342.473NLT



SMT Power Inductor

High Current Molded Power Inductor - PA4342.XXXNLT Series



For More Information

Pulse Worldwide Headquarters
15255 Innovation Drive Ste 100
San Diego, CA 92128
U.S.A.

Tel: 858 674 8100
Fax: 858 674 8262

Pulse Europe
Pulse Electronics GmbH
Am Rottland 12
58540 Meinerzhagen
Germany

Tel: 49 2354 777 100
Fax: 49 2354 777 168

Pulse China Headquarters
B402, Shenzhen Academy of
Aerospace Technology Bldg.
10th Kejinan Road
High-Tech Zone
Nanshan District
Shenzhen, PR China 518057

Tel: 86 755 33966678
Fax: 86 755 33966700

Pulse North China
Room 2704/2705
Super Ocean Finance Ctr.
2067 Yan An Road West
Shanghai 200336
China

Tel: 86 21 62787060
Fax: 86 2162786973

Pulse South Asia
135 Joo Seng Road
#03-02
PM Industrial Bldg.
Singapore 368363

Tel: 65 6287 8998
Fax: 65 6287 8998

Pulse North Asia
3F, No. 198
Zhongyuan Road
Zhongli City
Taoyuan County 320
Taiwan R. O. C.

Tel: 886 3 4356768
Fax: 886 3 4356823 (Pulse)
Fax: 886 3 4356820 (FRE)

Performance warranty of products offered on this data sheet is limited to the parameters specified. Data is subject to change without notice. Other brand and product names mentioned herein may be trademarks or registered trademarks of their respective owners. © Copyright, 2017. Pulse Electronics, Inc. All rights reserved.